TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

## TC74VHC367FN,TC74VHC368FN

Hex Bus Buffer

TC74VHC367FN Non-Inverted, 3-State

Outputs

TC74VHC368FN Inverted, 3-State

Outputs

The TC74VHC367 and 368 are advanced high speed CMOS HEX BUS BUFFERs fabricated with silicon gate C2MOS technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

They contain six buffers; four buffers are controlled by an enable input ( $\overline{G}1$ ), and the other two buffers are controlled by another enable input ( $\overline{G}2$ ). The outputs of each buffer group are enabled when  $\overline{G}1$  and/or  $\overline{G}2$  inputs are held low; if held high, these outputs are in a high impedance state.

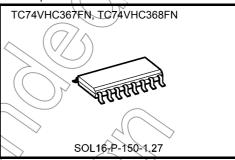
The TC74VHC367 is a non-inverting output type, while the TC74VHC368 is an inverting output type.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

#### **Features**

- High speed:  $t_{pd} = 3.8 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation: ICC = 4 µA (max) at Ta = 25°C
- High noise immunity: VNIH = VNIL = 28% VCC (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays: tpLH ≃ tpHL
- Wide operating voltage range: V<sub>CC</sub> (opr) = 2 V to 5.5 V
- Low noise: VOLP = 0.8 V/(max)
- Pin and function compatible with 74ALS367/368

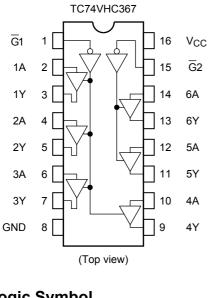




Weight SOL16-P-150-1.27:

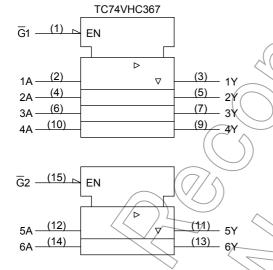
0.13 g (typ.)

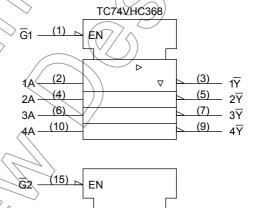
### **Pin Assignment**



#### TC74VHC368 G1 16 $V_{CC}$ G2 15 1A 2 1 $\overline{Y}$ 3 6A 6Y 2A 13 27 / 12 5A 5Y ЗА $3\overline{Y}$ 10 4A GND 9 (Top view)

### **IEC Logic Symbol**





 $\triangleright$ 

 $\nabla$ 

(11)\_\_ 5<u>Y</u>

(13) 6<u>Y</u>

(12)

(14)

Truth Table

			_
Inputs		Out	puts
G <	_ A (	Y (367)	Y (368)
L	1		> H
1		Н	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Н	X	Z	⟨ <u>Z</u>

X: Don't care

Z: High impedance

#### **Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	−0.5 to 7.0	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	-20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±50	)) mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

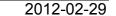
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	Vec	2.0 to 5.5	V
Input voltage	((VIN))	0 to 5.5	V
Output voltage	Vout	0 to Voc	V
Operating temperature	Topr	=40 to 85	°C
Input rise and fall time	dt/dv 〈	0 to 100 ( $V_{CC} = 3.3 \pm 0.3 \text{ V}$ ) 0 to 20 ( $V_{CC} = 5 \pm 0.5 \text{ V}$ )	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.





### **Electrical Characteristics**

### **DC Characteristics**

Characteristics	Symbol		Ta = 25°C			Ta −40 to	Unit			
			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max		
High-level input		_		2.0	1.50	_ <	\_	1.50	_	٧
voltage	$V_{IH}$			3.0 to 5.5	V <sub>CC</sub> × 0.7	_		V <sub>CC</sub> × 0.7	_	
Low-level input		_		2.0	_	_	0.50	) <u> </u>	0.50	V
voltage	V <sub>IL</sub>			3.0 to 5.5	$\leftarrow$	$\sqrt{\langle}$	Vcc × 0.3	_	V <sub>CC</sub> × 0.3	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	2.0	1.9	2.0	_	1.9	-	V
	Voн			3.0	2.9	3.0	<u> </u>	2.9	_	
High-level output voltage				4.5	4.4	4.5	_	4.4	_	
J			I <sub>OH</sub> = -4 mA	3.0	2.58	>		2.48	$\checkmark$	
			I <sub>OH</sub> = -8 mA	4.5	3.94	_	- 6	3.80	> -	
	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA	2.0	) +	0.0	0.1	) <del>/</del> ^	0.1	V
				3.0	_	0.0	0.1	4	0.1	
Low-level output voltage			6	4.5	_	0.0	0.1	$\supset$ $-$	0.1	
			I <sub>OL</sub> = 4 mA	3.0	_	_(	0.36	_	0.44	
			I <sub>OL</sub> = 8 mA	4.5	_	7/	0.36	_	0.44	
3-state output off-state current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND		5.5			±0.25	_	±2.50	μΑ
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5		))_	±0.1		±1.0	μΑ
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or	GND	5.5	_		4.0	_	40.0	μΑ



#### AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol Tes		st Condition		Ta = 25°C			Ta -40 to	Unit	
			V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	J
	t <sub>pLH</sub>	_	3.3 ± 0.3	15	_	5.9	8.3	1.0	10.0	ns
Propagation delay time				50	_	8.4	11.8	1.0	13.5	
(TC74VHC367)	$t_{pHL}$		5.0 ± 0.5	15	-	4.1	5.9	1.0	7.0	113
			3.0 1 0.5	50	1	5.6	(7.9	1.0	9.0	
			3.3 ± 0.3	15	-	5.3	7.5	1.0	9.0	
Propagation delay time	$t_{pLH}$	_	3.5 ± 0.5	50	_<	7.8	110	1.0	12.5	ns
(TC74VHC368)	t <sub>pHL</sub>		5.0 ± 0.5	15	->	3.8	5.5	1.0	6.5	
				50	-((	5.3	7.5	1.0	8.5	
	<sup>t</sup> pZL <sup>t</sup> pZH	R <sub>L</sub> = 1 kΩ	3.3 ± 0.3	15		6.8	10.5	1.0	12.5	
3-state output enable				50 <	1(-/	9.3	14.0	1.0	16.0	ns
time			5.0 ± 0.5	15		4.8	7.2	1.0	8.5	
				50	\ <u></u>	6.3	9.2	1.0	10.5	
3-state output disable	$t_{pLZ}$	$R_1 = 1 k\Omega$	$3.3 \pm 0.3$	50		9.9	13.6	(1,0)	15.5	ns
time	$t_{pHZ}$	11 - 1132	5.0 ± 0.5	(50)	-	6.3	9.2	1.0	10.5	113
Output to output skew	t <sub>osLH</sub>	(Note 1)	3.3 ± 0.3	50	-	40	1.5	_	1.5	ns
	t <sub>osHL</sub>	(14010-1)	5.0 ± 0.5	50	-		(1.0	_	1.0	113
Input capacitance	C <sub>IN</sub>		4	$\supset$	- (	(\/ <b>4</b> )	) 10	_	10	pF
Output capacitance	C <sub>OUT</sub>	<	1(-/>			6	_	_	_	pF
Power dissipation capacitance	C <sub>PD</sub>			(Note 2)		))19	_	_	_	pF

Note 1: Parameter guaranteed by design>

tosLH = |tpLHm - tpLHn|, tosHL = |tpHLm - tpHLn|

Note 2: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

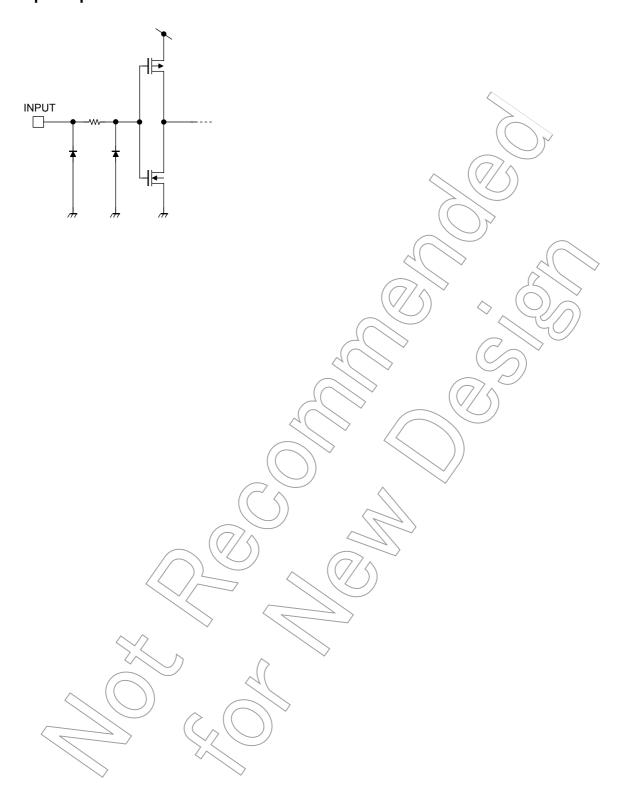
Average operating current can be obtained by the equation:

 $ICC (opr) = CPD \cdot VCC \cdot fIN + ICC / 6 (per bit)$ 

### Noise Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition			Ta = 25°C		
Characteristics	Symbol		V <sub>CC</sub> (V)	Тур.	Limit	Unit	
Quiet output maximum dynamic	VOLP	℃ <sub>L</sub> = 50 pF	5.0	0.4	0.8	٧	
Quiet output minimum dynamic VoL	VOLV	C <sub>L</sub> = 50 pF	5.0	-0.4	-0.8	٧	
Minimum high level dynamic input voltage	V <sub>IHD</sub>	C <sub>L</sub> = 50 pF	5.0	ı	3.5	<b>V</b>	
Maximum low level dynamic input voltage	$V_{ILD}$	C <sub>L</sub> = 50 pF	5.0	-	1.5	٧	

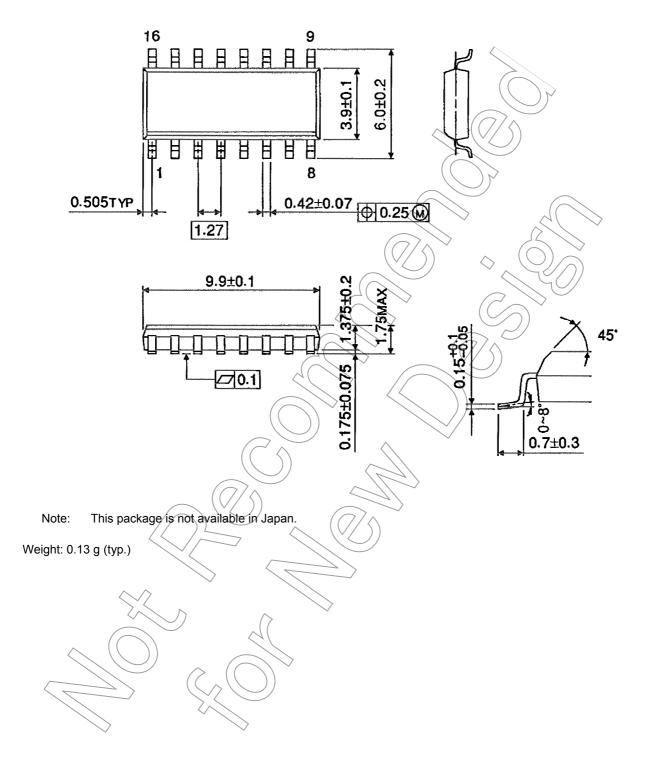
# Input Equivalent Circuit





### **Package Dimensions (Note)**

SOL16-P-150-1.27 Unit: mm



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